

NL-putty10

Non-Silicone Lightweight Thermal Conductive Putty

LiPOLY's NL-putty10 is a non-silicone, low-density gap filling material without volatile low-molecular-weight siloxane volatile, low total volatile gas. It is suitable for electronic products and automotive electronic devices. Its low density and lightweight characteristics improve product performance, reduce production costs, and minimize material usage and energy consumption. With a thermal conductivity of 10.0 W/m*K and high deformability, it can flexibly adapt to gap and has tolerance compensation properties. It can overcome overflow and drying problems, improve heat conduction, and is suitable for automated dispensing production.

FEATURES

- / Lightweight, Low Density, Thermal Conductivity: 10.0 W/m*K
- / High flow rate, extrusion rate under 90psi & 60s conditions: 20g/min
- / Bond line thickness: 100~1500µm
- / Non-silicone resin materials
- / Designed to remove manufacturing tolerances
- / Does not produce stress on delicate components
- / No vertical flow
- / Dispensable for serial manufacture
- / For any high compression and low stress application

TYPICAL APPLICATION

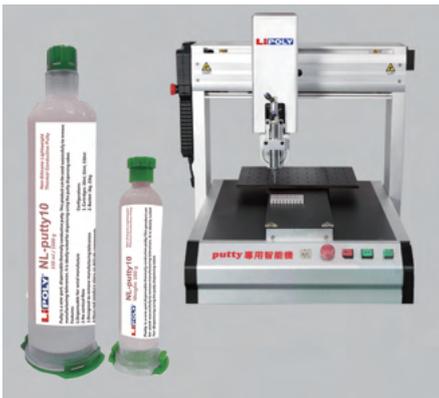
/ lightweight applications, such as Automotive electronic devices, Mobile communication device, Drone & aircraft, Sports and leisure electronic products, Portable computers and tablets, wearable devices, Portable game consoles, VR devices and etc.

CONFIGURATIONS

- / Cartridges: 30ml, 150ml
- / Bucket: 1kg, 25kg

PRESERVATION

It can be preserved for 60 months under the condition of unopened and under room temperature 30°C.



TYPICAL PROPERTIES

| PROPERTY | NL-putty10 | TEST METHOD | UNIT |
|---------------------------------------------------------------|-------------------|-------------|------------------------|
| Color | Gray red | Visual | - |
| Resin base | Non-Silicone | - | - |
| Viscosity | 10000 | DIN 53018 | Pa.s |
| Flow Rate (30cc EFD tube, 2.35mm Orifice diameter, 90psi&60s) | 20 | By LiPOLY | g/min |
| Density | 2.6 | ASTM D792 | g/cm ³ |
| Application temperature | -60~125 | - | °C |
| Bond line thickness | 100~1500 | - | µm |
| TML | <0.60 | By LiPOLY | % |
| Shelf life | 60 months | - | - |
| ROHS & REACH | Compliant | - | - |
| ELECTRICAL | | | |
| Dielectric breakdown | 10 | ASTM D149 | KV/mm |
| Volume resistivity | >10 ¹² | ASTM D257 | Ohm-m |
| THERMAL | | | |
| Thermal conductivity | 10.0 | ASTM D5470 | W/m*K |
| Thermal impedance@10psi / 80°C | 0.043 | ASTM D5470 | °C-in ² / W |
| Thermal impedance@30psi / 80°C | 0.039 | ASTM D5470 | °C-in ² / W |
| Thermal impedance@50psi / 80°C | 0.036 | ASTM D5470 | °C-in ² / W |

VERTICAL RELIABILITY

Using 1.5mm pad as a gap control, put the putty between the aluminum and the glass panel mark the initial position. Then, place it in the oven with 125°C for 1,000 hours and observe its displacement after reliability test

